

# Advantech

## AQD-D5V32GN56-SBH

### Datasheet

Rev. 1.0

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## Description

DDR5 1.1V Unbuffered DIMM is high-speed, low power memory module that use 2Gx8 bits DDR5 SDRAM in FBGA package and a 8192 bits serial EEPROM on a 288-pin printed circuit board. DDR5 1.1V Unbuffered DIMM is a Dual In-Line Memory Module and is intended for mounting into 288-pin edge connector sockets.

Synchronous design allows precise cycle control with the use of system clock. Data I/O transactions are possible on both edges of DQS. Range of operation frequencies, programmable latencies allow the same device to be useful for a variety of high bandwidth, high performance memory system applications.

## Features

- JEDEC standard compliant
- On-DIMM thermal sensor : Yes
- VDD = VDDQ= 1.1V (1.067V to 1.166V)
- VPP = 1.8V (1.746V to 1.908V) 、 VDDSPD = 1.8V
- 32 internal banks (x4, x8): 8 groups of 4 banks each
- 16 internal banks (x16): 4 groups of 4 banks each
- CAS Latency (CL): 22,26,28,30,32,36,40,42,46,48,50
- CAS Write Latency (CWL): RL-2
- Operating temperature Tcase= (0°C~85°C)
- Average Refresh period 3.9us at lower than Tcase 85°C, 1.95us at 85°C < Tcase < 95 °C.
- All bank and same bank refresh
- Bi-Directional Differential Data Strobe
- 16-bit prefetch architecture
- On-die ECC
- ECC transparency and error scrub
- sPPR and hPPR capability
- PCB: 30μ inch gold finger
- Halogen free 、 Lead-free (RoHS compliant)
- Anti-Sulfuration (Anti-FOS test: ASTM-B809-95)

## Pin Identification

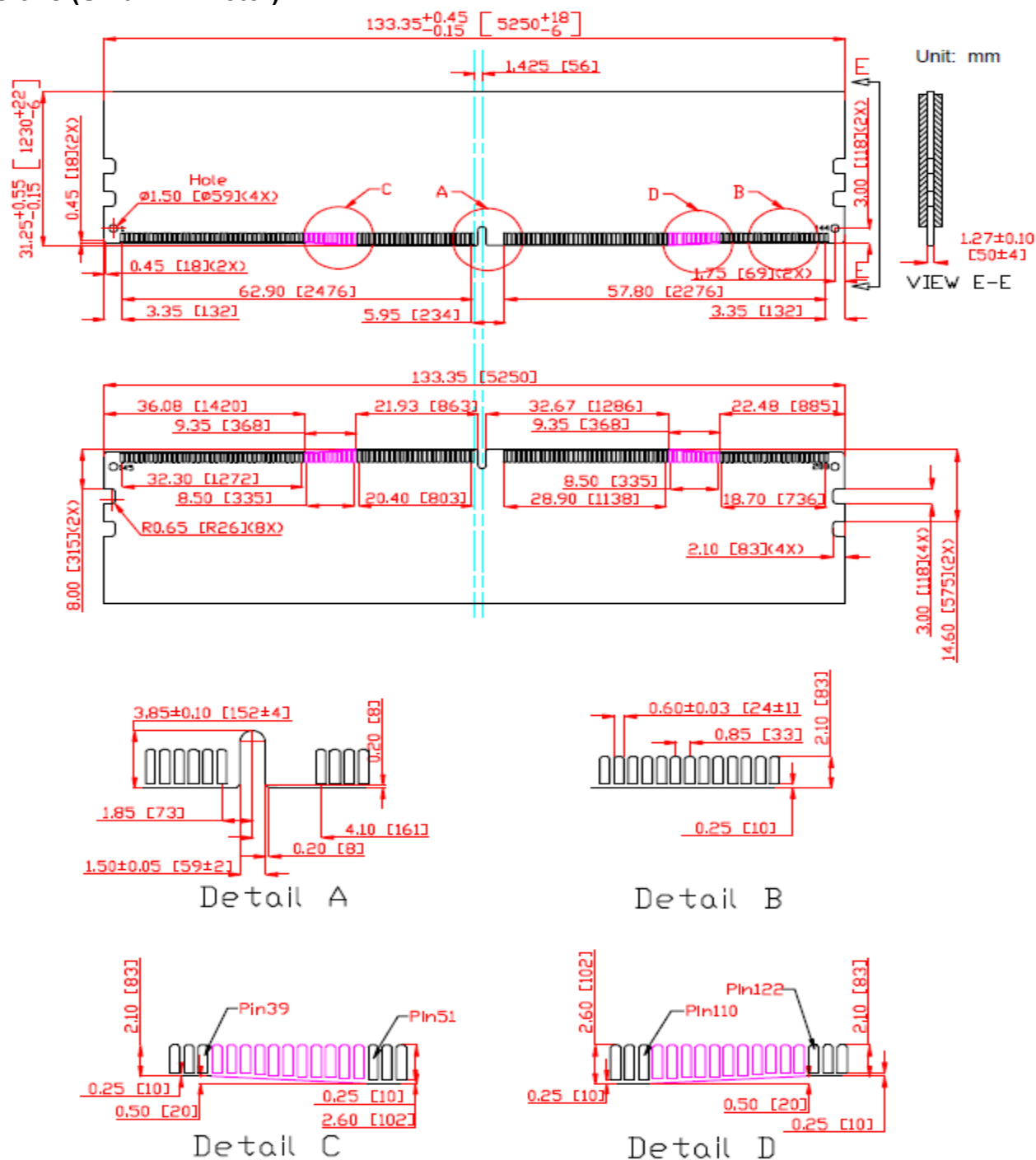
| Symbol                                      | Function                                                         |
|---------------------------------------------|------------------------------------------------------------------|
| CA0_A – CA12_A,<br>CA0_B – CA12_B           | SDRAM Command/Address bus                                        |
| CS0_A_n – CS1_A_n,<br>CS0_B_n – CS1_B_n     | SDRAM Chip Select                                                |
| DQ0_A – DQ31_A,<br>DQ0_B – DQ31_B           | DIMM memory data bus                                             |
| CB0_A – CB3_A,<br>CB0_B – CB3_B             | DIMM ECC check bits (Only applicable on ECC SODIMM or ECC UDIMM) |
| DQS0_A_t – DQS4_A_t,<br>DQS0_B_t – DQS4_B_t | SDRAM data strobes (positive line of differential pair)          |
| DQS0_A_c – DQS4_A_c,<br>DQS0_B_c – DQS4_B_c | SDRAM data strobes (negative line of differential pair)          |
| DM0_A_n – DM3_A_n,<br>DM0_B_n – DM3_B_n     | SDRAM data masks                                                 |
| CK0_A_t, CK1_A_t,<br>CK0_B_t, CK1_B_t       | SDRAM clocks (positive line of differential pair)                |
| CK0_A_c, CK1_A_c,<br>CK0_B_c, CK1_B_c       | SDRAM clocks (negative line of differential pair)                |
| HSCL                                        | Side Band bus clock                                              |
| HSDA                                        | Side Band bus data                                               |
| HSA                                         | Side Band bus address                                            |
| ALERT_n                                     | SDRAM ALERT_n                                                    |
| RESET_n                                     | Set DRAMs to a Known State                                       |
| VIN_BULK                                    | 5 V power input supply to the PMIC for analog circuits           |
| VSS                                         | Power supply return (ground)                                     |
| PWR_GOOD                                    | Power good indicator                                             |
| PWR_EN                                      | PMIC Enable                                                      |
| RFU                                         | Reserved for future use                                          |

\*Notes:

DDR5 UDIMM has 2 channels (channel-A and channel-B) of signal bus.

The signals with suffix: \_A (e.g. DQ0\_A) are for channel-A, and the signals with suffix: \_B (e.g. DQ0\_B) are for channel-B

## Dimensions (Unit: millimeter)



30µ inch gold finger

(All dimensions are in millimeters with ±0.15mm tolerance unless specified otherwise.)

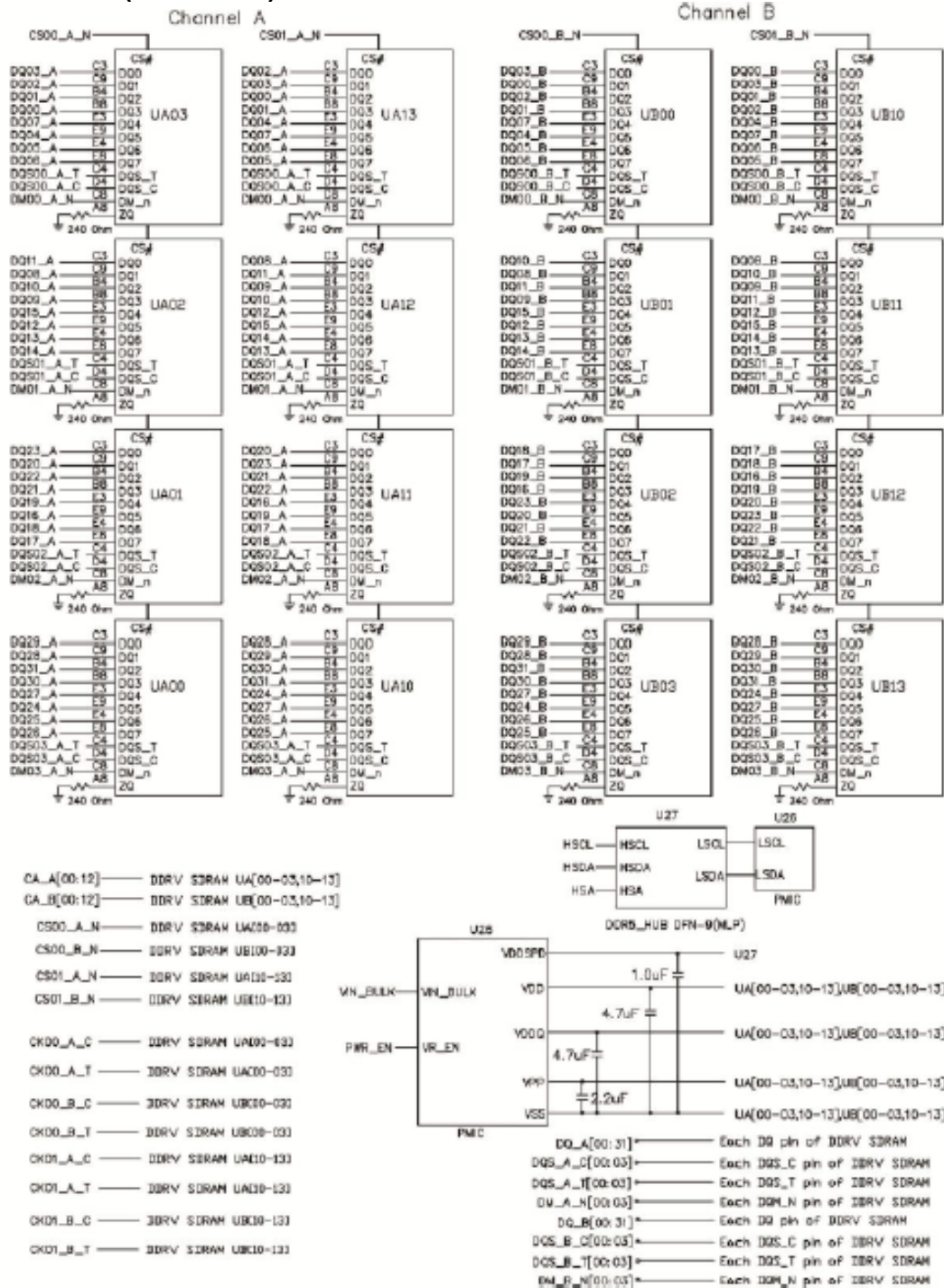
## Pin Assignments

| Pin No. | Front Side | Pin No. | Back Side  | Pin No. | Front Side | Pin No. | Back Side |
|---------|------------|---------|------------|---------|------------|---------|-----------|
| 1       | VIN_BULK   | 145     | VIN_BULK   | 74      | VSS        | 218     | VSS       |
| 2       | RFU        | 146     | VIN_BULK   | 75      | RFU        | 219     | RFU       |
| 3       | RFU        | 147     | PWR_- GOOD | 76      | RFU        | 220     | RFU       |
| 4       | HSCL       | 148     | HSA        | 77      | VSS        | 221     | VSS       |
| 5       | HSDA       | 149     | RFU        | 78      | CK0_B_t    | 222     | CK1_B_t   |
| 6       | VSS        | 150     | VSS        | 79      | CK0_B_c    | 223     | CK1_B_c   |
| 7       | RFU        | 151     | PWR_EN     | 80      | VSS        | 224     | VSS       |
| 8       | VSS        | 152     | RFU        | 81      | RFU        | 225     | RFU       |
| 9       | DQ0_A      | 153     | VSS        | 82      | CA12_B     | 226     | RFU       |
| 10      | VSS        | 154     | DQ2_A      | 83      | VSS        | 227     | VSS       |
| 11      | DQ1_A      | 155     | VSS        | 84      | CA10_B     | 228     | CA11_B    |
| 12      | VSS        | 156     | DQ3_A      | 85      | CA8_B      | 229     | CA9_B     |
| 13      | DQS0_A_c   | 157     | VSS        | 86      | VSS        | 230     | VSS       |
| 14      | DQS0_A_t   | 158     | DM0_A_n    | 87      | CA6_B      | 231     | CA7_B     |
| 15      | VSS        | 159     | VSS        | 88      | CA4_B      | 232     | CA5_B     |
| 16      | DQ4_A      | 160     | DQ6_A      | 89      | VSS        | 233     | VSS       |
| 17      | VSS        | 161     | VSS        | 90      | CA2_B      | 234     | CA3_B     |
| 18      | DQ5_A      | 162     | DQ7_A      | 91      | CA0_B      | 235     | CA1_B     |
| 19      | VSS        | 163     | VSS        | 92      | VSS        | 236     | VSS       |
| 20      | DQ8_A      | 164     | DQ10_A     | 93      | CS0_B_n    | 237     | CS1_B_n   |
| 21      | VSS        | 165     | VSS        | 94      | VSS        | 238     | VSS       |
| 22      | DQ9_A      | 166     | DQ11_A     | 95      | RESET_n    | 239     | DQS4_B_c  |
| 23      | VSS        | 167     | VSS        | 96      | VSS        | 240     | DQS4_B_t  |
| 24      | DM1_A_n    | 168     | DQS1_A_c   | 97      | CB0_B      | 241     | VSS       |
| 25      | VSS        | 169     | DQS1_A_t   | 98      | VSS        | 242     | CB2_B     |
| 26      | DQ12_A     | 170     | VSS        | 99      | CB1_B      | 243     | VSS       |
| 27      | VSS        | 171     | DQ14_A     | 100     | VSS        | 244     | CB3_B     |
| 28      | DQ13_A     | 172     | VSS        | 101     | DQ0_B      | 245     | VSS       |
| 29      | VSS        | 173     | DQ15_A     | 102     | VSS        | 246     | DQ2_B     |
| 30      | DQ16_A     | 174     | VSS        | 103     | DQ1_B      | 247     | VSS       |
| 31      | VSS        | 175     | DQ18_A     | 104     | VSS        | 248     | DQ3_B     |
| 32      | DQ17_A     | 176     | VSS        | 105     | DQS0_B_c   | 249     | VSS       |
| 33      | VSS        | 177     | DQ19_A     | 106     | DQS0_B_t   | 250     | DM0_B_n   |
| 34      | DQS2_A_c   | 178     | VSS        | 107     | VSS        | 251     | VSS       |
| 35      | DQS2_A_t   | 179     | DM2_A_n    | 108     | DQ4_B      | 252     | DQ6_B     |
| 36      | VSS        | 180     | VSS        | 109     | VSS        | 253     | VSS       |
| 37      | DQ20_A     | 181     | DQ22_A     | 110     | DQ5_B      | 254     | DQ7_B     |
| 38      | VSS        | 182     | VSS        | 111     | VSS        | 255     | VSS       |
| 39      | DQ21_A     | 183     | DQ23_A     | 112     | DQ8_B      | 256     | DQ10_B    |

| Pin No. | Front Side | Pin No. | Back Side | Pin No. | Front Side | Pin No. | Back Side |
|---------|------------|---------|-----------|---------|------------|---------|-----------|
| 40      | VSS        | 184     | VSS       | 113     | VSS        | 257     | VSS       |
| 41      | DQ24_A     | 185     | DQ26_A    | 114     | DQ9_B      | 258     | DQ11_B    |
| 42      | VSS        | 186     | VSS       | 115     | VSS        | 259     | VSS       |
| 43      | DQ25_A     | 187     | DQ27_A    | 116     | DM1_B_n    | 260     | DQS1_B_c  |
| 44      | VSS        | 188     | VSS       | 117     | VSS        | 261     | DQS1_B_t  |
| 45      | DM3_A_n    | 189     | DQS3_A_c  | 118     | DQ12_B     | 262     | VSS       |
| 46      | VSS        | 190     | DQS3_A_t  | 119     | VSS        | 263     | DQ14_B    |
| 47      | DQ28_A     | 191     | VSS       | 120     | DQ13_B     | 264     | VSS       |
| 48      | VSS        | 192     | DQ30_A    | 121     | VSS        | 265     | DQ15_B    |
| 49      | DQ29_A     | 193     | VSS       | 122     | DQ16_B     | 266     | VSS       |
| 50      | VSS        | 194     | DQ31_A    | 123     | VSS        | 267     | DQ18_B    |
| 51      | CB0_A      | 195     | VSS       | 124     | DQ17_B     | 268     | VSS       |
| 52      | VSS        | 196     | CB2_A     | 125     | VSS        | 269     | DQ19_B    |
| 53      | CB1_A      | 197     | VSS       | 126     | DQS2_B_c   | 270     | VSS       |
| 54      | VSS        | 198     | CB3_A     | 127     | DQS2_B_t   | 271     | DM2_B_n   |
| 55      | DQS4_A_c   | 199     | VSS       | 128     | VSS        | 272     | VSS       |
| 56      | DQS4_A_t   | 200     | ALERT_n   | 129     | DQ20_B     | 273     | DQ22_B    |
| 57      | VSS        | 201     | VSS       | 130     | VSS        | 274     | VSS       |
| 58      | CS0_A_n    | 202     | CS1_A_n   | 131     | DQ21_B     | 275     | DQ23_B    |
| 59      | VSS        | 203     | VSS       | 132     | VSS        | 276     | VSS       |
| 60      | CA0_A      | 204     | CA1_A     | 133     | DQ24_B     | 277     | DQ26_B    |
| 61      | CA2_A      | 205     | CA3_A     | 134     | VSS        | 278     | VSS       |
| 62      | VSS        | 206     | VSS       | 135     | DQ25_B     | 279     | DQ27_B    |
| 63      | CA4_A      | 207     | CA5_A     | 136     | VSS        | 280     | VSS       |
| 64      | CA6_A      | 208     | CA7_A     | 137     | DM3_B_n    | 281     | DQS3_B_c  |
| 65      | VSS        | 209     | VSS       | 138     | VSS        | 282     | DQS3_B_t  |
| 66      | CA8_A      | 210     | CA9_A     | 139     | DQ28_B     | 283     | VSS       |
| 67      | CA10_A     | 211     | CA11_A    | 140     | VSS        | 284     | DQ30_B    |
| 68      | VSS        | 212     | VSS       | 141     | DQ29_B     | 285     | VSS       |
| 69      | CA12_A     | 213     | RFU       | 142     | VSS        | 286     | DQ31_B    |
| 70      | RFU        | 214     | RFU       | 143     | RFU        | 287     | VSS       |
| 71      | VSS        | 215     | VSS       | 144     | RFU        | 288     | RFU       |
| 72      | CK0_A_t    | 216     | CK1_A_t   |         |            |         |           |
| 73      | CK0_A_c    | 217     | CK1_A_c   |         |            |         |           |

### Block Diagram

#### 32GB, 4Gx64 Module (2 Rank x8)



This technical information is based on industry standard data and tests believed to be reliable. However, Advantech makes no warranties, either expressed or implied, as to its accuracy and assume no liability in connection with the use of this product. Advantech reserves the right to make changes in specifications at any time without prior notice.

## Operating Temperature Condition

| Parameter                      | Symbol         | Rating    | Unit | Note      |
|--------------------------------|----------------|-----------|------|-----------|
| Normal Operating Temperature   | Toper normal   | -20 to 85 | °C   | 1,2,3,4   |
| Extended Operating Temperature | Toper extended | 85 to 95  |      | 1,2,3,4,5 |

Note:

1. All operating temperature symbols, ranges, acronyms are referred from JESD402-1.
2. Operating Temperature is the case surface temperature on the center/top side of the DRAM. For the measurement conditions, please refer to JESD51-2 standard.
3. All DDR5 SDRAMs are required to operate in NT and XT temperature ranges.
4. If TC exceeds 85°C, the DRAM must be refreshed externally at 2X refresh, which is a 1.95µs interval refresh rate.
5. Operating Temperature for 3DS needs to be derated by the number of DRAM dies as:  $[T_{OPER} - (2.5^{\circ}\text{C} \times \log_2 N)]$ , where N is the number of the stacked dies.

## Absolute Maximum DC Ratings

| Parameter                           | Symbol    | Rating       | Units | Notes |
|-------------------------------------|-----------|--------------|-------|-------|
| Voltage on VDD pin relative to Vss  | VDD       | - 0.3 ~ 1.4  | V     | 1     |
| Voltage on VDDQ pin relative to Vss | VDDQ      | - 0.3 ~ 1.4  | V     | 1     |
| Voltage on VPP pin relative to Vss  | VPP       | - 0.3 ~ 2.1  | V     |       |
| Voltage on any pin relative to Vss  | VIN, VOUT | - 0.3 ~ 1.4  | V     | 1     |
| Storage temperature                 | TSTG      | - 55 to +100 | °C    | 1,2   |

Note:

1. Stresses greater than those listed in this table may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. Storage temperature is the case surface temperature on the center/top side of the device. For the measurement conditions, refer to JESD51-2 standard.

## AC & DC Operating Conditions

### DIMM Voltage Requirements

| Symbol   | Parameter                  | Voltage Rating (Volts) |         |         | Maximum Expected Current (Amps) | Power State |
|----------|----------------------------|------------------------|---------|---------|---------------------------------|-------------|
|          |                            | Minimum                | Typical | Maximum |                                 |             |
| VIN_BULK | Host Supply Voltage        | 4.25                   | 5.0     | 5.5     | 2.A                             | Operational |
| SWA,SWB  | PMIC Output Supply Voltage | -                      | 1.1     | -       | Note 9                          | Operational |
| SWA+SWB  | PMIC Output Supply Voltage | -                      | 1.1     | -       | Note 9                          | Operational |
| SWC      | PMIC Output Supply Voltage | -                      | 1.8     | -       | Note 9                          | Operational |
| 1.8V LDO | PMIC Output Supply Voltage | -                      | 1.8     | -       | 0.025(maximum)                  | Operational |
| 1.0V LDO | PMIC Output Supply Voltage | -                      | 1.0     | -       | 0.020(maximum)                  | Operational |

### NOTE:

1. Input supplies referenced in this table are VIN\_BULK and VIN.
2. During first power-on, the input voltage supply must reach a minimum of 4.25V for the PMIC to detect a valid input supply.
3. The ramp up rate is between 300mV and 4.0V.
4. The ramp down rate is between 4.0V and 300mV.
5. The area under the curve and above VIN\_Bulk = TBD. The VIN\_Bulk\_AC spec must also be satisfied.
6. The minimum input current requirement is equal to the maximum output current on VOUT\_1.8V and VOUT\_1.0V LDO, plus the current required by the PMIC for its own use. The maximum input current is equal to the all VIN\_Bulk input on the PMIC.
7. VIN\_Bulk = 5.0V measured at room temperature. All circuitry, including output regulators and LDOs are off. The VR\_EN

signal is static LOW or HIGH. The GSI\_n signal is pulled HIGH. I2C or 13C basic interface access is not allowed, and the bus is pulled HIGH. The PID signal is pulled either HIGH or LOW

8. VIN\_Bulk = 5.0V measured at room temperature. All output regulators and LDOs are on the 0A output load. The VR\_EN signal is static LOW or HIGH. The GSI\_n signal is pulled HIGH. I2C or 13C basic interface access is not allowed, and the bus is pulled HIGH. The PID signal is pulled either HIGH or LOW.
9. Maximum and Minimum Current ratings depend on PMIC (5100)

## SERIAL PRESENCE DETECT SPECIFICATION

32768MB((4096Mx64Bit) Serial Presence Detect for DDR5 UDIMM (PC-44800) 5600 CL=46-45-45

| BYTE | FUNCTION DESCRICED                                     | FUNCTION SUPPORTED                                                                                                                   | HEX VALUE |
|------|--------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|-----------|
| 0    | Number of Bytes in SPD Device                          | 1024 bytes                                                                                                                           | 30        |
| 1    | SPD Revision for Base Configuration Parameters         | Revision 1.0                                                                                                                         | 10        |
| 2    | Key Byte / Host Bus Command Protocol Type              | DDR5 SDRAM                                                                                                                           | 12        |
| 3    | Key Byte / Module Type                                 | UDIMM                                                                                                                                | 02        |
| 4    | First SDRAM Density and Package                        | Monolithic SDRAM, 16Gb                                                                                                               | 04        |
| 5    | First SDRAM Addressing                                 | 16 rows, 10 columns                                                                                                                  | 00        |
| 6    | First SDRAM I/O Width                                  | x8                                                                                                                                   | 20        |
| 7    | First SDRAM Bank Groups & Banks Per Bank Group         | 8 bank groups, 4 banks per bank group                                                                                                | 62        |
| 8    | Second SDRAM Density and Package                       | Symmetrical                                                                                                                          | 00        |
| 9    | Second SDRAM Addressing                                | Symmetrical                                                                                                                          | 00        |
| 10   | Second SDRAM I/O Width                                 | Symmetrical                                                                                                                          | 00        |
| 11   | Second SDRAM Bank Groups & Banks Per Bank Group        | Symmetrical                                                                                                                          | 00        |
| 12   | SDRAM BL32 & Post Package Repair                       | MBIST/mPPR, BL32, sPPR Undo/Lock supported, one repair element per bank                                                              | B2        |
| 13   | SDRAM Duty Cycle Adjuster & Partial Array Self Refresh | PASR supported, Device supports DCA for 4-phase internal clocks                                                                      | 12        |
| 14   | SDRAM Fault Handling                                   | Wide temperature sense and reporting, Bounded Fault supported, Writeback suppression control in MR9, Writeback suppression supported | 0D        |
| 15   | RESERVED                                               | must be coded as 00                                                                                                                  | 00        |
| 16   | SDRAM Nominal Voltage, VDD                             | 1.1V                                                                                                                                 | 00        |
| 17   | SDRAM Nominal Voltage, VDDQ                            | 1.1V                                                                                                                                 | 00        |
| 18   | SDRAM Nominal Voltage, VPP                             | 1.8V                                                                                                                                 | 00        |
| 19   | SDRAM Timing                                           | SDRAM uses standard core timings per JESD79-5                                                                                        | 00        |
| 20   | SDRAM Minimum Cycle Time (tCKAVGmin) LSB               | 0.357ns                                                                                                                              | 65        |
| 21   | SDRAM Minimum Cycle Time (tCKAVGmin) MSB               | 0.357ns                                                                                                                              | 01        |
| 22   | SDRAM Maximum Cycle Time (tCKAVGmax), LSB              | 1.010ns                                                                                                                              | F2        |
| 23   | SDRAM Maximum Cycle Time (tCKAVGmax), MSB              | 1.010ns                                                                                                                              | 03        |
| 24   | CAS Latencies Supported, First Byte                    | 50,46,42,40,36,32,30,28,26,22                                                                                                        | 7A        |
| 25   | CAS Latencies Supported, Second Byte                   | 50,46,42,40,36,32,30,28,26,22                                                                                                        | AD        |
| 26   | CAS Latencies Supported, Third Byte                    | 50,46,42,40,36,32,30,28,26,22                                                                                                        | 00        |

|    |                                                                                            |                                 |    |
|----|--------------------------------------------------------------------------------------------|---------------------------------|----|
| 27 | CAS Latencies Supported, Fourth Byte                                                       | 50,46,42,40,36,32,30,28,26,22   | 00 |
| 28 | CAS Latencies Supported, Fifth Byte                                                        | 50,46,42,40,36,32,30,28,26,22   | 00 |
| 29 | RESERVED                                                                                   | must be coded as 00             | 00 |
| 30 | SDRAM Minimum CAS Latency Time (tAamin), LSB                                               | 16.000                          | 80 |
| 31 | SDRAM Minimum CAS Latency Time (tAamin), MSB                                               | 16.000                          | 3E |
| 32 | SDRAM Minimum RAS to CAS Delay Time (tRCDmin), LSB                                         | 16.000                          | 80 |
| 33 | SDRAM Minimum RAS to CAS Delay Time (tRCDmin), MSB                                         | 16.000                          | 3E |
| 34 | SDRAM Minimum Row Precharge Delay Time (tRPmin), LSB                                       | 16.000                          | 80 |
| 35 | SDRAM Minimum Row Precharge Delay Time (tRPmin), MSB                                       | 16.000                          | 3E |
| 36 | SDRAM Minimum Active to Precharge Delay Time (tRASmin), LSB                                | 32.000                          | 00 |
| 37 | SDRAM Minimum Active to Precharge Delay Time (tRASmin), MSB                                | 32.000                          | 7D |
| 38 | SDRAM Minimum Active to Active/Refresh Delay Time (tRCmin), LSB                            | 48.000                          | 80 |
| 39 | SDRAM Minimum Active to Active/Refresh Delay Time (tRCmin), MSB                            | 48.000                          | BB |
| 40 | SDRAM Minimum Write Recovery Time (tWRmin), LSB                                            | 30.000                          | 30 |
| 41 | SDRAM Minimum Write Recovery Time (tWRmin), MSB                                            | 30.000                          | 75 |
| 42 | SDRAM Minimum Refresh Recovery Delay Time (tRFC1min, tRFC1_slr min), LSB                   | 295                             | 27 |
| 43 | SDRAM Minimum Refresh Recovery Delay Time (tRFC1min, tRFC1_slr min), MSB                   | 295                             | 01 |
| 44 | SDRAM Minimum Refresh Recovery Delay Time (tRFC2min, tRFC2_slr min), LSB                   | 160                             | A0 |
| 45 | SDRAM Minimum Refresh Recovery Delay Time (tRFC2min, tRFC2_slr min), MSB                   | 160                             | 00 |
| 46 | SDRAM Minimum Refresh Recovery Delay Time (tRFCsbmin, tRFCsb_slr min), LSB                 | 130                             | 82 |
| 47 | SDRAM Minimum Refresh Recovery Delay Time (tRFCsbmin, tRFCsb_slr min), MSB                 | 130                             | 00 |
| 48 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFC1_dlr min), LSB  | must be coded as 00             | 00 |
| 49 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFC1_dlr min), MSB  | must be coded as 00             | 00 |
| 50 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFC2_dlr min), LSB  | must be coded as 00             | 00 |
| 51 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFC2_dlr min), MSB  | must be coded as 00             | 00 |
| 52 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFCsb_dlr min), LSB | must be coded as 00             | 00 |
| 53 | SDRAM Minimum Refresh Recovery Delay Time, 3DS Different Logical Rank(tRFCsb_dlr min), MSB | must be coded as 00             | 00 |
| 54 | SDRAM Refresh Management, First Byte, First SDRAM                                          | Refresh management not required | 00 |
| 55 | SDRAM Refresh Management, Second Byte, First SDRAM                                         | Refresh management not required | 00 |
| 56 | SDRAM Refresh Management, First Byte, Second SDRAM                                         | Refresh management not required | 00 |

|    |                                                                                                                   |                                          |    |
|----|-------------------------------------------------------------------------------------------------------------------|------------------------------------------|----|
| 57 | SDRAM Refresh Management, Second Byte, Second SDRAM                                                               | Refresh management not required          | 00 |
| 58 | SDRAM Adaptive Refresh Management Level A, First Byte, First SDRAM                                                | Adaptive refresh management not required | 00 |
| 59 | SDRAM Adaptive Refresh Management Level A, Second Byte, First SDRAM                                               | Adaptive refresh management not required | 00 |
| 60 | SDRAM Adaptive Refresh Management Level A, First Byte, Second SDRAM                                               | Adaptive refresh management not required | 00 |
| 61 | SDRAM Adaptive Refresh Management Level A, Second Byte, Second SDRAM                                              | Adaptive refresh management not required | 00 |
| 62 | SDRAM Adaptive Refresh Management Level B, First Byte, First SDRAM                                                | Adaptive refresh management not required | 00 |
| 63 | SDRAM Adaptive Refresh Management Level B, Second Byte, First SDRAM                                               | Adaptive refresh management not required | 00 |
| 64 | SDRAM Adaptive Refresh Management Level B, First Byte, Second SDRAM                                               | Adaptive refresh management not required | 00 |
| 65 | SDRAM Adaptive Refresh Management Level B, Second Byte, Second SDRAM                                              | Adaptive refresh management not required | 00 |
| 66 | SDRAM Adaptive Refresh Management Level C, First Byte, First SDRAM                                                | Adaptive refresh management not required | 00 |
| 67 | SDRAM Adaptive Refresh Management Level C, Second Byte, First SDRAM                                               | Adaptive refresh management not required | 00 |
| 68 | SDRAM Adaptive Refresh Management Level C, First Byte, Second SDRAM                                               | Adaptive refresh management not required | 00 |
| 69 | SDRAM Adaptive Refresh Management Level C, Second Byte, Second SDRAM                                              | Adaptive refresh management not required | 00 |
| 70 | SDRAM Activate to Activate Command Delay for Same Bank Group (tRRD_L), Least Significant Byte                     | 5000ps                                   | 88 |
| 71 | SDRAM Activate to Activate Command Delay for Same Bank Group (tRRD_L), Most Significant Byte                      | 5000ps                                   | 13 |
| 72 | SDRAM Activate to Activate Command Delay for Same Bank Group (tRRD_L), Lower Clock Limit                          | 8CK                                      | 08 |
| 73 | SDRAM Read to Read Command Delay for Same Bank Group (tCCD_L), Least Significant Byte                             | 5000ps                                   | 88 |
| 74 | SDRAM Read to Read Command Delay for Same Bank Group (tCCD_L), Most Significant Byte                              | 5000ps                                   | 13 |
| 75 | SDRAM Read to Read Command Delay for Same Bank Group (tCCD_L), Lower Clock Limit                                  | 8CK                                      | 08 |
| 76 | SDRAM Write to Write Command Delay for Same Bank Group (tCCD_L_WR), Least Significant Byte                        | 20000ps                                  | 20 |
| 77 | SDRAM Write to Write Command Delay for Same Bank Group (tCCD_L_WR), Most Significant Byte                         | 20000ps                                  | 4E |
| 78 | SDRAM Write to Write Command Delay for Same Bank Group (tCCD_L_WR), Lower Clock Limit                             | 32CK                                     | 20 |
| 79 | SDRAM Write to Write Command Delay for Same Bank Group, Second Write not RMW (tCCD_L_WR2), Least Significant Byte | 10000ps                                  | 10 |
| 80 | SDRAM Write to Write Command Delay for Same Bank Group, Second Write not RMW (tCCD_L_WR2), Most Significant Byte  | 10000ps                                  | 27 |
| 81 | SDRAM Write to Write Command Delay for Same Bank Group, Second Write not RMW (tCCD_L_WR2), Lower Clock Limit      | 16CK                                     | 10 |
| 82 | SDRAM Four Activate Window (tFAW), Least Significant Byte                                                         | 11428ps                                  | A4 |
| 83 | SDRAM Four Activate Window (tFAW), Most Significant Byte                                                          | 11428ps                                  | 2C |
| 84 | SDRAM Four Activate Window (tFAW), Lower Clock Limit                                                              | 32CK                                     | 20 |
| 85 | SDRAM Write to Read Command Delay for Same Bank Group (tCCD_L_WTR), Least Significant Byte                        | 10000ps                                  | 10 |
| 86 | SDRAM Write to Read Command Delay for Same Bank Group (tCCD_L_WTR), Most Significant Byte                         | 10000ps                                  | 27 |

|        |                                                                                                 |                     |    |
|--------|-------------------------------------------------------------------------------------------------|---------------------|----|
| 87     | SDRAM Write to Read Command Delay for Same Bank Group (tCCD_L_WTR), Lower Clock Limit           | 16CK                | 10 |
| 88     | SDRAM Write to Read Command Delay for Different Bank Group (tCCD_S_WTR), Least Significant Byte | 2500ps              | C4 |
| 89     | SDRAM Write to Read Command Delay for Different Bank Group (tCCD_S_WTR), Most Significant Byte  | 2500ps              | 09 |
| 90     | SDRAM Write to Read Command Delay for Different Bank Group, (tCCD_S_WTR), Lower Clock Limit     | 4CK                 | 04 |
| 91     | SDRAM Read to Precharge Command Delay (tRTP, tRTP_slr), Least Significant Byte                  | 7500ps              | 4C |
| 92     | SDRAM Read to Precharge Command Delay (tRTP, tRTP_slr), Most Significant Byte                   | 7500ps              | 1D |
| 93     | SDRAM Read to Precharge Command Delay (tRTP, tRTP_slr), Lower Clock Limit                       | 12CK                | 0C |
| 94-191 | RESERVED                                                                                        | must be coded as 00 | 00 |
| 192    | SPD Revision for Module Information                                                             | Revision 1.0        | 10 |
| 193    | RESERVED                                                                                        |                     | 00 |
| 194    | SPD Manufacturer ID Code, First Byte                                                            | installed           | 00 |
| 195    | SPD Manufacturer ID Code, Second Byte                                                           | installed           | 00 |
| 196    | SPD Device Type                                                                                 | installed           | 00 |
| 197    | SPD Device Revision Number                                                                      | installed           | 00 |
| 198    | PMIC 0 Manufacturer ID Code, First Byte                                                         | installed           | 00 |
| 199    | PMIC 0 Manufacturer ID Code, Second Byte                                                        | installed           | 00 |
| 200    | PMIC 0 Device Type                                                                              | installed           | 00 |
| 201    | PMIC 0 Revision Number                                                                          | installed           | 00 |
| 202    | PMIC 1 Manufacturer ID Code, First Byte                                                         | Not installed       | 00 |
| 203    | PMIC 1 Manufacturer ID Code, Second Byte                                                        | Not installed       | 00 |
| 204    | PMIC 1 Device Type                                                                              | Not installed       | 00 |
| 205    | PMIC 1 Revision Number                                                                          | Not installed       | 00 |
| 206    | PMIC 2 Manufacturer ID Code, First Byte                                                         | Not installed       | 00 |
| 207    | PMIC 2 Manufacturer ID Code, Second Byte                                                        | Not installed       | 00 |
| 208    | PMIC 2 Device Type                                                                              | Not installed       | 00 |
| 209    | PMIC 2 Revision Number                                                                          | Not installed       | 00 |
| 210    | Thermal Sensors Manufacturer ID Code, First Byte                                                | Not installed       | 00 |
| 211    | Thermal Sensors Manufacturer ID Code, Second Byte                                               | Not installed       | 00 |
| 212    | Thermal Sensors Device Type                                                                     | Not installed       | 00 |
| 213    | Thermal Sensors Revision Number                                                                 | Not installed       | 00 |

|         |                                                            |                                        |    |
|---------|------------------------------------------------------------|----------------------------------------|----|
| 214-229 | RESERVED                                                   |                                        | 00 |
| 230     | Module Nominal Height                                      | 31.25mm                                | 11 |
| 231     | Module Maximum Thickness                                   | 1.2mm                                  | 11 |
| 232     | Reference Raw Card Used                                    | B0                                     | 01 |
| 233     | DIMM Attributes                                            | XT, Heat spreader not installed, 1 row | 82 |
| 234     | Module Organization                                        | Symmetrical, 2 PKG Rank                | 08 |
| 235     | Memory Channel Bus Width                                   | 2 channels, 0 bits, 32 bits            | 22 |
| 236     | RESERVED                                                   |                                        | 00 |
| 237     | RESERVED                                                   |                                        | 00 |
| 238     | RESERVED                                                   |                                        | 00 |
| 239     | RESERVED                                                   |                                        | 00 |
| 240     | Registering Clock Driver Manufacturer ID Code, First Byte  | Not installed                          | 00 |
| 241     | Registering Clock Driver Manufacturer ID Code, Second Byte | Not installed                          | 00 |
| 242     | Register Device Type                                       | Not installed                          | 00 |
| 243     | Register Revision Number                                   | Not installed                          | 00 |
| 244     | RESERVED                                                   | Not installed                          | 00 |
| 245     | RESERVED                                                   | Not installed                          | 00 |
| 246     | Data Buffer Device Type                                    | Not installed                          | 00 |
| 247     | Data Buffer Revision Number                                | Not installed                          | 00 |
| 248     | RCD-RW08 Clock Driver Enable                               | Enabled                                | 00 |
| 249     | RCD-RW09 Output Address and Control Enable                 | Enabled                                | 00 |
| 250     | RCD-RW0A QCK Driver Characteristics                        | must be coded as 00                    | 00 |
| 251     | RCD-RW0B                                                   | must be coded as 00                    | 00 |
| 252     | RCD-RW0C QxCA and QxCS_n Driver Characteristics            | must be coded as 00                    | 00 |
| 253     | RCD-RW0D Data Buffer Interface Driver Characteristics      | must be coded as 00                    | 00 |
| 254     | RCD-RW0E QCK, QCA and QCS Output Slew Rate                 | must be coded as 00                    | 00 |
| 255     | RCD-RW0F BCK, BCOM, and BCS Output Slew Rate               | must be coded as 00                    | 00 |
| 256     | DB-RW86 DQS RTT Park Termination                           | must be coded as 00                    | 00 |
| 257-509 | RESERVED                                                   |                                        | 00 |
| 510     | CRC for SPD bytes 0~509                                    | CRC cover 0~509 byte                   | B3 |
| 511     | CRC for SPD bytes 0~509                                    | CRC cover 0~509 byte                   | CD |

|         |                                          |             |    |
|---------|------------------------------------------|-------------|----|
| 512     | Module Manufacturer ID Code, First Byte  | Advantech   | 8A |
| 513     | Module Manufacturer ID Code, Second Byte | Advantech   | C8 |
| 514     | Module Manufacturing Location            | Variable    | 00 |
| 515     | Module Manufacturing Date                | Variable    | 00 |
| 516     | Module Manufacturing Date                | Variable    | 00 |
| 517     | Module Serial Number                     | Variable    | 00 |
| 518     | Module Serial Number                     | Variable    | 00 |
| 519     | Module Serial Number                     | Variable    | 00 |
| 520     | Module Serial Number                     | Variable    | 00 |
| 521     | Module Part Number                       | A           | 41 |
| 522     | Module Part Number                       | Q           | 51 |
| 523     | Module Part Number                       | D           | 44 |
| 524     | Module Part Number                       | -           | 2D |
| 525     | Module Part Number                       | D           | 44 |
| 526     | Module Part Number                       | 5           | 35 |
| 527     | Module Part Number                       | V           | 56 |
| 528     | Module Part Number                       | 3           | 33 |
| 529     | Module Part Number                       | 2           | 32 |
| 530     | Module Part Number                       | G           | 47 |
| 531     | Module Part Number                       | N           | 4E |
| 532     | Module Part Number                       | 5           | 35 |
| 533     | Module Part Number                       | 6           | 36 |
| 534     | Module Part Number                       | -           | 2D |
| 535     | Module Part Number                       | S           | 53 |
| 536     | Module Part Number                       | B           | 42 |
| 537     | Module Part Number                       | H           | 48 |
| 538     | Module Part Number                       | Blank Space | 20 |
| 539     | Module Part Number                       | Blank Space | 20 |
| 540     | Module Part Number                       | Blank Space | 20 |
| 541     | Module Part Number                       | Blank Space | 20 |
| 542     | Module Part Number                       | Blank Space | 20 |
| 543     | Module Part Number                       | Blank Space | 20 |
| 544     | Module Part Number                       | Blank Space | 20 |
| 545     | Module Part Number                       | Blank Space | 20 |
| 546     | Module Part Number                       | Blank Space | 20 |
| 547     | Module Part Number                       | Blank Space | 20 |
| 548     | Module Part Number                       | Blank Space | 20 |
| 549     | Module Part Number                       | Blank Space | 20 |
| 550     | Module Part Number                       | Blank Space | 20 |
| 551     | Module Revision Code                     | Revision 0  | 00 |
| 552     | DRAM Manufacturer's ID Code, First Byte  | Variable    | 00 |
| 553     | DRAM Manufacturer's ID Code, Second Byte | Variable    | 00 |
| 554     | DRAM Stepping                            | Undefined   | FF |
| 555-637 | Module Manufacturer's Specific Data      |             | 00 |



Enabling an Intelligent Planet

288 Pin DDR5 1.1V 5600 UDIMM  
32GB Based on 2Gx8  
AQD-D5V32GN56-SBH

|          |          |    |
|----------|----------|----|
| 638-1023 | RESERVED | 00 |
|----------|----------|----|

# Tento produkt můžete zakoupit u společnosti AutoCont IPC a.s.



## AutoCont IPC a.s.

Váš dodavatel průmyslových počítačů, komponent a speciálních průmyslových IT systémů.

 Uhlířská 1064/3, 710 00 Ostrava, Česká republika

 obchod@autocont-ipc.cz

 +420 552 301 002

 [www.autocont-ipc.cz](http://www.autocont-ipc.cz)



### PRŮMYSLOVÉ POČÍTAČE

*fanless embedded PC, do racku, ...*



### POČÍTAČE S DISPLEJEM

*panelové PC, terminály, do vozidel, ...*



### AUTOMATIZACE A SBĚR DAT

*převodníky, karty, moduly, switche, ...*



### PERIFERIE A KOMPONENTY

*monitory, klávesnice, desky, skříně, ...*



### NOTEBOOKY A TABLETY

*odolné, windows, android, IP65, ...*



### INFORMAČNÍ KIOSKY

*interiérové, venkovní, ...*



### MEDICÍNSKÁ TECHNIKA

*počítače, tablety, LCD, klávesnice, ...*



### SOFTWAREVÁ ŘEŠENÍ

*pro výrobu, zaměstnance, kiosky, ...*



### PŘEJÍT DO E-SHOPU

[eshop.autocont-ipc.cz](http://eshop.autocont-ipc.cz)



### DOPRAVA ZDARMA

Doprava zdarma v ČR a SR při objednávce nad 10 000 Kč bez DPH nebo nad 400 EUR.



### PRODLOUŽENÁ ZÁRUKA

Záruka 2 roky na vyráběné počítače s možností jejího prodloužení až na 5 let.



### ODMĚNA ZA VĚRNOST

Pravidelní zákazníci u nás nakupují za nižší ceny. Výše slevy se odvíjí od realizovaného obrátu.



### SERVIS ON-SITE A IN-TIME

K projektovým dodávkám nabízíme rozšířenou podporu a servis s garancí výměny zařízení do 48 hodin.